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Customer Approved Specification

To:

Product Name: M150GNN2 R1

Document Issue Date: 2015/05/22

Customer	InfoVision Optoelectronics
<u>SIGNATURE</u>	<u>SIGNATURE</u>
	REVIEWED BY CQM
	PREPARED BY FAE
Please return 1 copy for your confirmation with	
your signature and comments.	

Note: 1. Please contact InfoVision Company. before designing your product based on this product.

2. The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by IVO for any intellectual property claims or other problems that may result from application based on the module described herein.

FQ-7-30-0-009-03D

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Revision	Date	Page	Old Description	New Description	Remark
00	2015/05/22	All		First issued	

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1.0 General Descriptions

1.1 Introduction

The M150GNN2 R1 is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This model is composed of a TFT LCD panel, a driver circuit and a backlight system. This TFT LCD has a 15 inch diagonally measured active display area with XGA resolution (1,024 horizontal by 768 vertical pixels array).

1.2 Features

- Supported XGA Resolution
- LVDS Interface
- Compatible with RoHS Standard

1.3 Product Summary

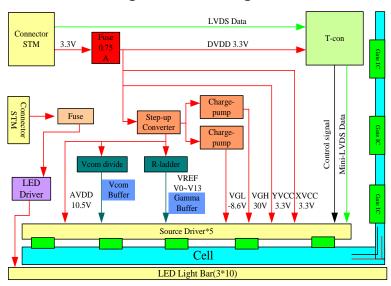
Items	Specifications	Unit
Screen Diagonal	15.0	inch
Active Area (H x V)	304.13 x 228.10	mm
Number of Pixels (H x V)	1,024 x 768	-
Pixel Pitch (H x V)	0.2970 x 0.2970	mm
Pixel Arrangement	R.G.B. Vertical Stripe	-
Display Mode	Normally White	-
White Luminance	420 (Typ.)	cd /m ²
Contrast Ratio	800 (Typ.)	-
Response Time	16 (Typ.)	ms
Input Voltage	3.3 (Typ.)	V
Power Consumption	8.8 (Max.)	W
Weight	960 (Max.)	g
Outline Dimension (H x V x D)	326.50 (Typ.) x 253.50(Typ.) x 12.50 (Max.)	mm
Electrical Interface (Logic)	LVDS	-
Support Color	16.2 M	-
NTSC	70 (Typ.)	%
Viewing Direction	6 O'clock	-
Surface Treatment	Anti-glare, Hard-Coating (3H)	-

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1.4 Functional Block Diagram

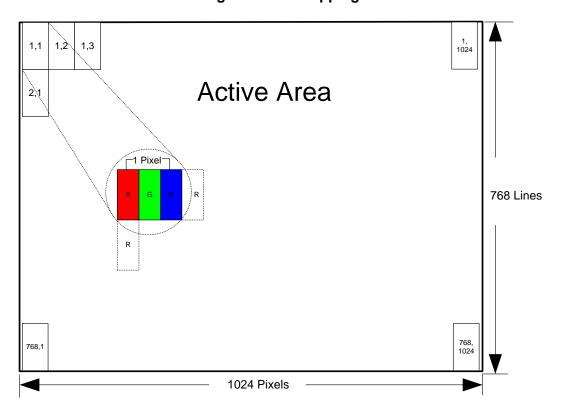
Figure 1 shows the functional block diagram of the LCD module.

Figure 1 Block Diagram



1.5 Pixel Mapping

Figure 2 Pixel Mapping



2.0 Absolute Maximum Ratings

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Table 1 Electrical & Environment Absolute Rating

Item	Symbol	Min.	Max.	Unit	Note
Logic Supply Voltage	V_{DD}	-0.5	5.0	V	(1),(2)
Operating Temperature	Тор	-20	70	$^{\circ}\! \mathbb{C}$	(2) (4) (5) (6)
Storage Temperature	Тѕт	-30	80	$^{\circ}$ C	(3),(4),(5),(6)
Vibration(Non-operating)	VB	-	1.5	G	(7)
Shock(Non-operating)	Shock	-	50	G	(8)

- Note (1) Permanent damage may occur to the LCD module if beyond this specification. Functional operation should be restricted to the conditions described under normal operating conditions.
- Note (2) Operating temperature 25 °C, humidity 55%RH.
- Note (3) (T<= 40° C) Note static electricity. Maximum wet bulb temperature at 39° C or less. (T> 40° C) No condensation.
- Note (4) There is a possibility of causing deterioration in the irregularity and others of the screen and the display fineness though the liquid crystal module doesn't arrive at destruction when using it at $60\sim70^{\circ}$ C or $-20\sim0^{\circ}$ C.
- Note (5) There is a possibility of causing the fineness deterioration by the prolonged use in the (high temperature) humidity environment (60%RH or more).
- Note (6) In the operating temperature item, the low temperature side is the ambient temperature regulations. The high temperature side is the panel surface temperature regulations.
- Note (7) 10-200Hz, random vibration, 30min for X, Y, Z axis.
- Note (8) 20ms, half sine wave, one time for X, Y, Z axis.

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3.0 Optical Characteristics

The optical characteristics are measured under stable conditions as following notes.

Table 2 Optical Characteristics

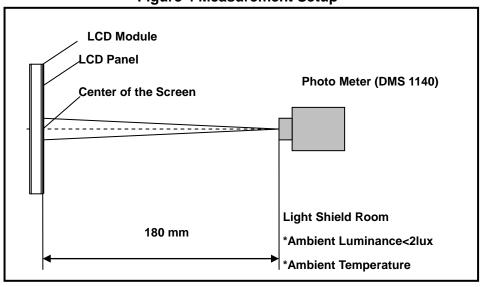
Item	Conditions		Min.	Тур.	Max.	Unit	Note	
	Horizontal	θ *+	70	80	-			
Viewing Angle	Horizoniai	θ _{x-}	70	80	-	dograo	(1) (2) (2)	
(CR>10)	Vertical	θ _{y+}	70	80	ı	degree	(1),(2),(3)	
	vertical	θ _{y-}	60	80	-			
Contrast Ratio	Center		450	800	_	_	(1),(2),(4)	
Contrast Natio	Ceriter		430	800	-	-	$\theta x=\theta y=0^{\circ}$	
D Time	Distance Falling			40	05		(1),(2),(5)	
Response Time	Rising + Falling	9	-	16	25	ms	$\theta x=\theta y=0^{\circ}$	
	Red x			0.625		-		
	Red y Green x Green y Blue x		Тур. -0.03	0.352	Typ. +0.03	-	(1),(2),(3) θx=θy=0°	
Color				0.315		-		
Chromaticity				0.630		-		
(CIE1931)				0.149		-		
(OIL 1931)	Blue y			0.067		-		
	White x		0.255	0.305	0.355	-		
	White y		0.275	0.325	0.375	-		
NTSC	_		_	70	_	%	(1),(2),(3)	
NTOO			_	70		70	$\theta x=\theta y=0^{\circ}$	
White Luminance	Center		_	420	_	cd/m ²	(1),(2),(6)	
TTING Editination	lince Center			120		00/111	$\theta x=\theta y=0^{\circ}$	
Luminance	9 Points		75	80	_	%	(1),(2),(6)	
Uniformity	0.00		, 0			,,	$\theta x=\theta y=0^{\circ}$	

Note (1) Measurement Setup:

The LCD module should be stabilized at given temperature (25°C) for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.

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Figure 4 Measurement Setup



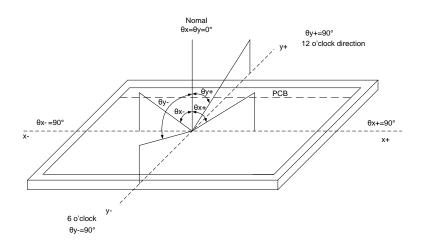
Note (2) The LED input parameter setting as:

VLED: 12V;

PWM_LED: Duty 100 %

Note (3) Definition of Viewing Angle

Figure 5 Definition of Viewing Angle



Note (4) Definition Of Contrast Ratio (CR)

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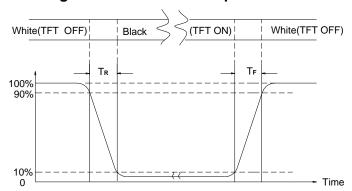
The contrast ratio can be calculated by the following expression:

Contrast Ratio (CR) = L255 / L0

L255: Luminance of gray level 255, L0: Luminance of gray level 0

Note (5) Definition Of Response Time (T_R, T_F)

Figure 6 Definition of Response Time

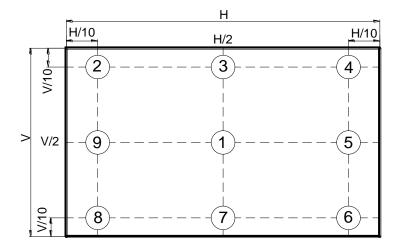


Note (6) Definition Of Luminance Uniformity (Ref.: Active Area) Measure the luminance of gray level 255 at 9 points.

Luminance Uniformity= Min.(L1, L2, ... L9) / Max.(L1, L2, ... L9)

H—Active Area Width, V—Active Area Height, L—Luminance

Figure 8 Measurement Locations of 9 Points



4.0 Electrical Characteristics

4.1 Interface Connector

Table 5 Signal Connector Type

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Item	Description
Manufacturer / Type	MSB240420HD
Mating Receptacle / Type (Reference)	P240420 or compatible

Table 6 Signal Connector Pin Assignment

Pin No.	Symbol	Description	Remarks
1	VDD	Power Supply, 3.3V (typical)	-
2	VDD	Power Supply, 3.3V (typical)	-
3	VSS	Ground	-
4	REV	Reverse Scan selection	Note(1)
5	Rin1-	-LVDS differential data input (R0-R5,G0)	-
6	Rin1+	+LVDS differential data input (R0-R5,G0)	-
7	VSS	Ground	-
8	Rin2-	-LVDS differential data input (G1-G5,B0-B1)	-
9	Rin2+	+LVDS differential data input (G1-G5,B0-B1)	-
10	VSS	Ground	-
11	Rin3-	-LVDS differential data input (B2-B5,HS,VS,DE)	-
12	Rin3+	+LVDS differential data input (B2-B5,HS,VS,DE)	-
13	VSS	Ground	-
14	CIkIN-	-LVDS differential clock input	-
15	CIkIN+	+LVDS differential clock input	-
16	GND	Ground	-
17	Rin4-	-LVDS differential data input (R6-R7,G6-G7,B6-B7)	-
18	Rin4+	+VDS differential data input (R6-R7,G6-G7,B6-B7)	-
19	VSS	Ground	-
20	NC	Not connect	-

Note (1) REV = LOW/NC



REV = High

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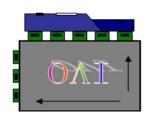


Table 6 LED Connector Name / Designation

Item	Description
Connector Name/Designation	LED Driver Connector
Manufacturer	STM or compatible
Connector Model Number	MSB24038P5A or compatible
Mating Model Number	P24038P5A or compatible

Table 7 LED Connector Pin Assignment

Pin No.	Symbol	Description	Remarks
1	Vcc	12V	-
2	GND	GND	-
3	Enable	5V-On / 0V-Off	-
4	Dimming	PWM Dimming	-
5	NC	NC	-

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4.2 Interface Timings

Table 8 Interface Timings

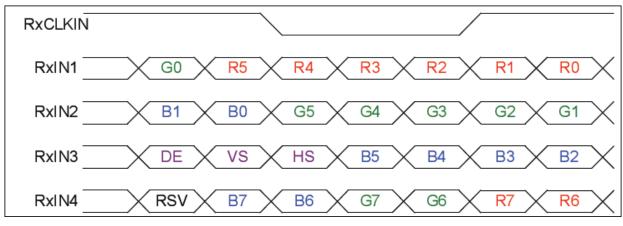
Parameter	Symbol	Min.	Тур.	Max.	Unit
LVDS Clock Frequency	Fclk	50	65	80	MHz
H Total Time	HT	1,056	1,344	1,720	Clocks
H Active Time	HA	1,024	1,024	1,024	Clocks
V Total Time	VT	772	806	990	Lines
V Active Time	VA	768	768	768	Lines
Frame Rate	FV	55	60	70	Hz

Note (1) Synchronization Method: DE only

Note (2) H Blank area and V Blank area can not be changed at every frame.

4.3 Timing Diagram of Interface Signal

Figure 6 Timing Characteristics



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4.4 Input Power Specifications

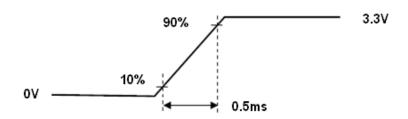
Input power specifications are as follows.

Table 9 Input Power Specifications

Parameter		Symbol	Min.	Тур.	Max.	Unit	Note		
System Powe	System Power Supply								
LCD Drive Volt	tage (Logic)	V_{DD}	3.0	3.3	3.6	V	(2), (4)		
VDD Current	Black Pattern	I _{DD}	ı	0.25	ı	А			
VDD Power Consumption	Black Pattern	P _{DD}	-	•	1.3	W	(3),(4)		
Rush Current		I _{Rush}	ı	ı	3	А	(1),(4),(5)		
Allowable Logic/LCD Drive Ripple Voltage		V_{VDD-RP}	-	-	200	mV	(4)		
LED Power St	upply								
LED Input Volt	age	V_{LED}	10.8	12	12.6	V	(4)		
LED Power Co	nsumption	P _{LED}	-	-	7.5	W	(4)		
PWM Signal	High	\/	3.3	5	5.5	V			
Voltage	Low	V_{PWM}	-	-	0.8	V			
LED Enable	High		2.0	5	5.5	V	(4)		
Voltage	Low	V_{LED_EN}	-	-	0.8	V			
Input PWM Fre	equency	F _{PWM}	200	-	20K	Hz			
LED Life Time		LT	30,000	50000	-	Hours	(4),(6)		

Note (1) Measure Condition

Figure 14 VDD Rising Time

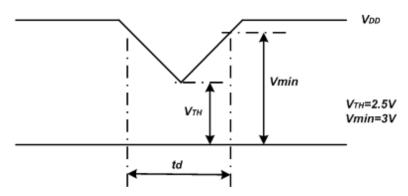


Note (2) VDD Power Dip Condition

 V_{TH} < V_{DD} \leq Vmin, td \leq 10ms (a time of the voltage return to normal), our panel can revive automatically.

Figure 15 VDD Power Dip

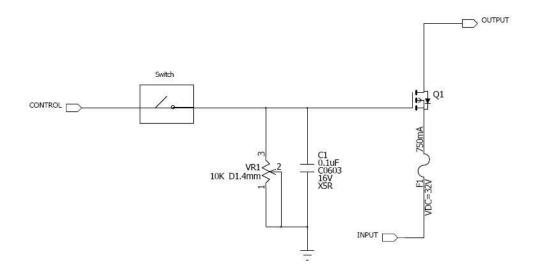
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Note (3) Frame Rate=60Hz, VDD=3.3V, DC Current.

Note (4) Operating temperature 25℃, humidity 55%RH.

Note (5) The reference measurement circuit of rush current.



Note (6) The LED life time define as the estimated time to 50% degradation of initial luminous.

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4.5 Power ON/OFF Sequence

Interface signals are also shown in the chart. Signals from any system shall be Hi- resistance state or low level when VDD voltage is off.

Figure 16 Power Sequence

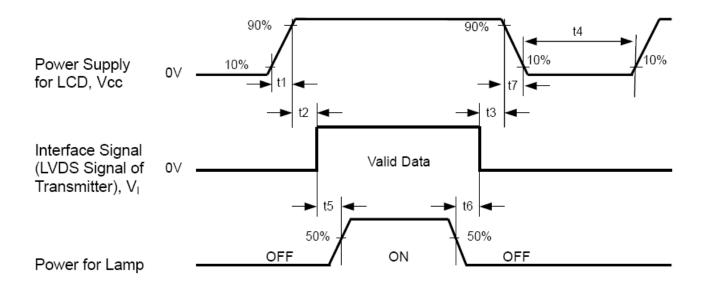


Table 10 Power Sequencing Requirements

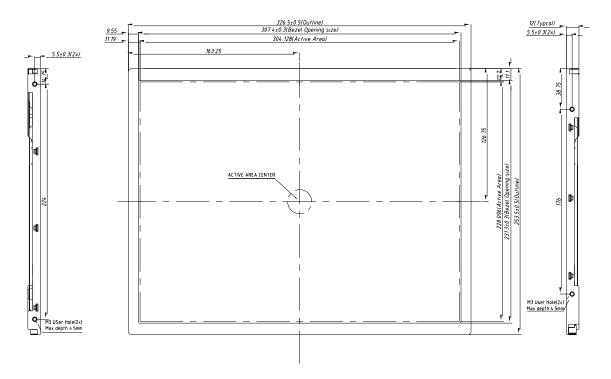
Parameter	Symbol	Min.	Тур.	Max.	Unit
VDD Rise Time	T1	0.5	ı	10	ms
VDD Good to Signal Valid	T2	0	-	20	ms
Signal Disable to Power Down	Т3	0	ı	1000	ms
Power Off	T4	1000	-		ms
Signal Valid to Backlight On	T5	300	-		ms
Backlight Off to Signal Disable	T6	200	-		ms
VDD Fall Time	T7	0	-	100	ms

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5.0 Mechanical Characteristics

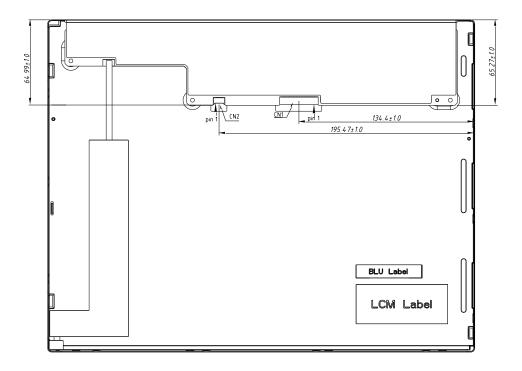
5.1 Outline Drawing

Figure 17 Reference Outline Drawing (Front Side)



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Figure 18 Reference Outline Drawing (Back Side)



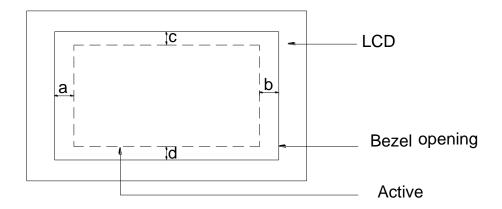
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5.2 Dimension Specifications

Table 11 Module Dimension Specifications

Item	Min.	Тур.	Max.	Unit
Width	326.0	326.5	327.0	mm
Height	253.0	253.5	254.0	mm
Thickness	11.5	12.0	12.5	mm
Weight	-	930	960	g

Figure 19 BM Area



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6.0 Reliability Conditions

It	em	Package		Test Conditions	Note		
High Temperatur	e Operating Test	Module	70℃, 300 hours		(1),(2),(3),(4)		
Low Temperature	e Operating Test	Module	-20℃, 30	00 hours	(1),(2),(3),(4)		
High Temperatur	e Storage Test	Module	80℃, 30	0 hours	(1),(2),(4)		
Low Temperature	e Storage Test	Module	-30℃, 30	00 hours	(1),(2),(4)		
High Temperature/High Humidity Operating Test		Module	50℃, 85%RH, 300 hours		50°C, 85%RH, 300 hours (1		(1),(2),(3),(4)
Thermal Shock N	Non-operation	Module	-20°C ~60°C ,1hr/each cycle, 100cycles		(1),(2),(4)		
Shock Non-opera	ating Test	Module	50G,20m Y,±Z)	ns,Half Sine Wave,(\pm X, \pm	(4)		
Vibration Non-op	perating Test	Module	1.5G , 10 axis/30m)~200 Hz , x、y、z each in	(4)		
	Operating		Contact	± 8 KV, 150pF(330Ohm)			
ECD Took	Operating	Module	Air	± 15 KV, 150pF(330Ohm)	(5)		
ESD Test		iviodule	Contact	± 10 KV, 150pF(330Ohm)	(5)		
	inon-operating	on-operating		± 20 KV, 150pF(330Ohm)			

Note (1) All the judgments are under room temperature and the sample need to be static more than 2 hours in the room temperature before judge.

Note (2) During measurement, the condensation water or remains shall not be allowed.

Note (3) In operating test, the backlight voltage and current must be in speccfication.

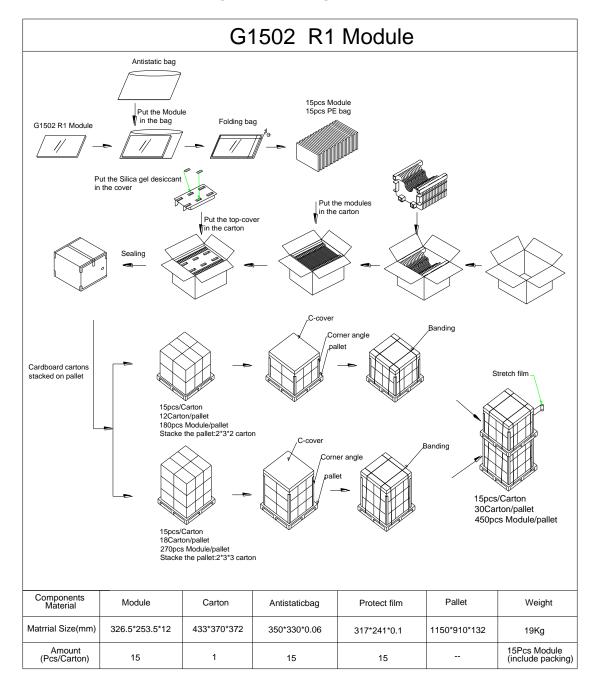
Note (4) There is no display function issue occurred, all the cosmetic specification is judged before the reliability stress.

Note (5) In case of malfunction defect caused by ESD damage. If it would be recovered to normal state after resetting, it would be judge as pass.

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7.0 Package Specification

Figure 20 Packing Method



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8.0 Lot Mark



Note: This picture is only an example.

8.1 20 Lot Mark

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	
---	---	---	---	---	---	---	---	---	----	----	----	----	----	----	----	----	----	----	----	--

Code 1,2,4,5,6,7,8,9,10,11,16: IVO internal flow control code.

Code 3: Production Location.

Code 12: Production Year.

Code 13: Production Month.

Code 14,15: Production Day.

Code 17,18,19,20: Serial Number.

8.2 23 Product Barcode

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23
																						i

Code 1,2: Manufacture District.

Code 3,4,5,6,7: IVO internal module name.

Code 8,9,10,13,16: IVO internal flow control code.

Code 11,12: Cell location Suzhou, China defined as "KS".

Code 14,15: Module location Kunshan, China defined as "KS"; Yangzhou, China defined as "YZ"; Shenzhen, China defined as "SE"; Zhuhai, China defined as "ZH"; Suzhou, China defined as "SZ".

Code 17,18,19: Year, Month, Day refer to Note(1), Note(2) and Note(3).

Note (1) Production Year

Year	2006	2007	2008	2009	2010	2011	2012	2013	 2035
Mark	6	7	8	9	Α	В	С	D	 Z

Note (2) Production Month

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Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct	Nov.	Dec.
Mark	1	2	3	4	5	6	7	8	9	Α	В	С

Note (3) Production Day: 1~V. Code 20~23: Serial Number.

9.0 General Precaution

9.1 Use Restriction

This product is not authorized for use in life supporting systems, aircraft navigation control systems, military systems and any other application where performance failure could be life-threatening or otherwise catastrophic.

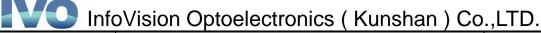
9.2 Handling Precaution

- (1) Please mount LCD module by using mounting holes arranged in four corners tightly.
- (2) Do not disassemble or modify the module. It may damage sensitive parts inside LCD module, and may cause scratches or dust on the display. IVO does not warrant the module, if customers disassemble or modify the module.
- (3) If LCD panel is broken and liquid crystal spills out, do not ingest or inhale liquid crystal, and do not contact liquid crystal with skin. If liquid crystal contacts mouth or eyes, rinse out with water immediately. If liquid crystal contacts skin or cloths, wash it off immediately with alcohol and rinse thoroughly with water.
- (4) Disconnect power supply before handling LCD module.
- (5) Refrain from strong mechanical shock and /or any force to the module.
- (6) Do not exceed the absolute maximum rating values, such as the supply voltage variation, input voltage variation, variation in parts parameters, environmental temperature; etc otherwise LCD module may be damaged. It's recommended employing protection circuit for power supply.
- (7) Do not touch, push or rub the polarizer with anything harder than HB pencil lead. Use fingerstalls of soft gloves in order to keep clean display quality, when persons handle the LCD module for incoming inspection or assembly.
- (8) When the surface is dusty, please wipe gently with absorbent cotton or other soft material. When cleaning the adhesives, please use absorbent cotton wetted with a little petroleum benzene or other adequate solvent.
- (9) Wipe off saliva or water drops as soon as possible. If saliva or water drops contact with polarizer for a long time, they may causes deformation or color fading.
- (10) Protection film must remove very slowly from the surface of LCD module to prevent from electrostatic occurrence.
- (11) Because LCD module uses CMOS-IC on circuit board and TFT-LCD panel, it is very weak to electrostatic discharge, please be careful with electrostatic discharge. Persons who handle the module should be grounded through adequate methods.
- (12) Do not adjust the variable resistor located on the module.

9.3 Storage Precaution

- (1) Please do not leave LCD module in the environment of high humidity and high temperature for a long time.
- (2) The module shall not be exposed under strong light such as direct sunlight. Otherwise, display characteristics may be changed.
- (3) The module should be stored in a dark place. It is prohibited to apply sunlight or fluorescent light in storage.

9.4 Operation Precaution



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- (1) Do not connect or disconnect the module in the "Power On" condition.
- (2) Power supply should always be turned on/off by "Power On/Off Sequence".
- (3) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference should be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- (4) After installation of the TFT module into an enclosure, do not twist nor bend the TFT module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT module from outside. Otherwise the TFT module may be damaged.

9.5 Others

- (1) Ultra-violet ray filter is necessary for outdoor operation.
- (2) Avoid condensation of water which may result in improper operation or disconnection of electrode.
- (3) If the module keeps displaying the same pattern for a long period of time, the image may be "sticked" to the screen.
- (4) This module has its circuitry PCB's on the rear side and should be handled carefully in order not to be stressed.

9.6 Disposal

When disposing LCD module, obey the local environmental regulations.